

**QT-Brightek Chip LED Series****SMD 0603 Yellow Green LED****Part No.: QBLP601-YG**

---

**Table of Contents:**

Introduction .....	3
Electrical / Optical Characteristic (Ta=25 °C) .....	4
Absolute Maximum Rating .....	4
Solder Profile & Footprint .....	6
Packing .....	7
Labeling .....	8
Ordering Information .....	8
Revision History .....	9
Disclaimer .....	9

## Introduction

**Feature:**

- Water clear lens
- Package in tape and reel
- Ultra bright 0603 LED package
- GaP technology

**Description:**

These ultra bright 0603 LEDs have a height profile of 0.60mm. Combination of high brightness output and small footprint, these LEDs are ideal for keypad backlighting and status indication.

**Application:**

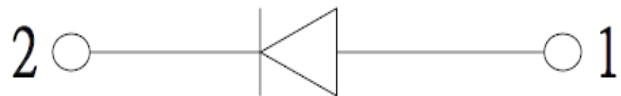
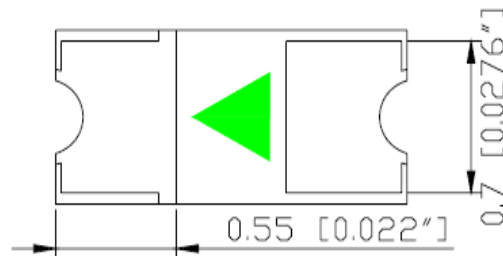
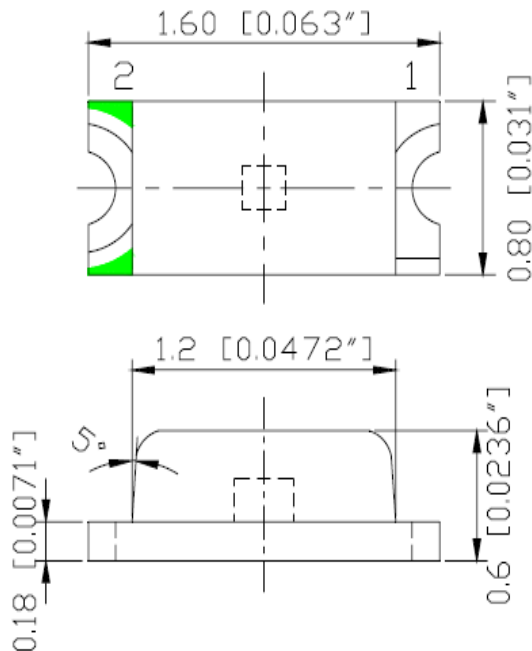
- Status indication
- Back lighting application

**Certification & Compliance:**

- TS16949
- ISO9001
- RoHS Compliant



**Dimension:**



Units: mm / tolerance = +/-0.2mm

### Electrical / Optical Characteristic (Ta=25 °C)

Product	Color	I <sub>F</sub> (mA)	V <sub>F</sub> (V)			λ <sub>D</sub> (nm)			I <sub>V</sub> (mcd)	
			Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.
QBLP601-YG	Yellow	10	1.6	-	2.5	568	570	576	-	5
	Green	20	1.6	2.0	2.5				5	10

### Absolute Maximum Rating

Material	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> (mA)*	V <sub>R</sub> (V)	T <sub>OP</sub> (°C)	T <sub>ST</sub> (°C)	T <sub>SO L</sub> (°C)**
GaP	80	30	100	5	-40 ~ +85	-40 ~ +100	260

\*Duty 1/10 @ 10KHz

\*\*IR Reflow for no more than 10 sec @ 260 °C

### Forward Voltage V<sub>F</sub> @ I<sub>F</sub>=20mA

Bin	Min.	Max.	Unit
b	1.6	1.9	V
c	1.9	2.2	
d	2.2	2.5	

### Luminous Intensity I<sub>V</sub> @ I<sub>F</sub>=20mA

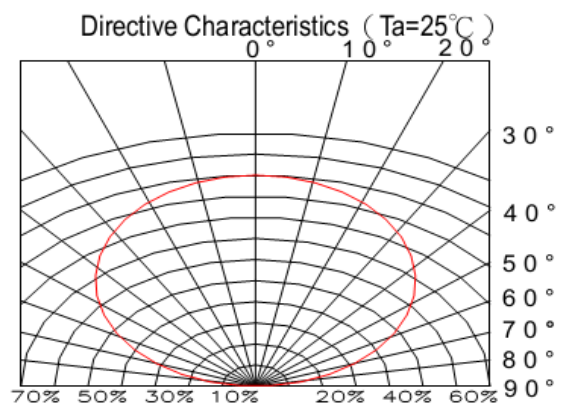
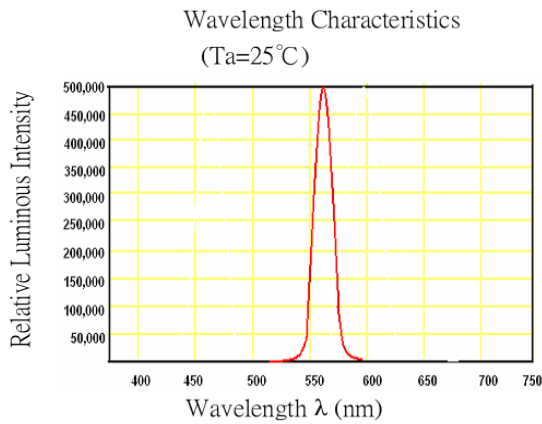
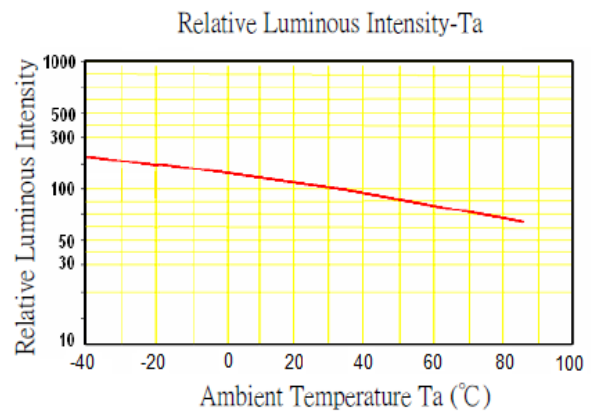
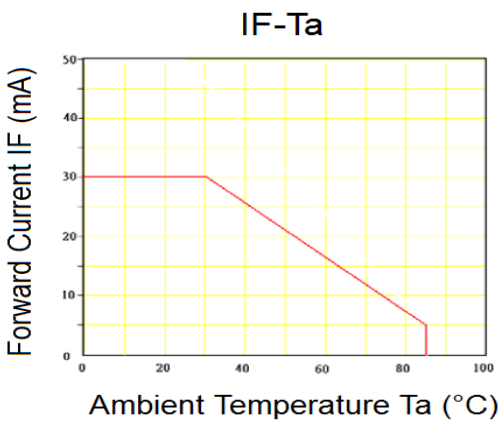
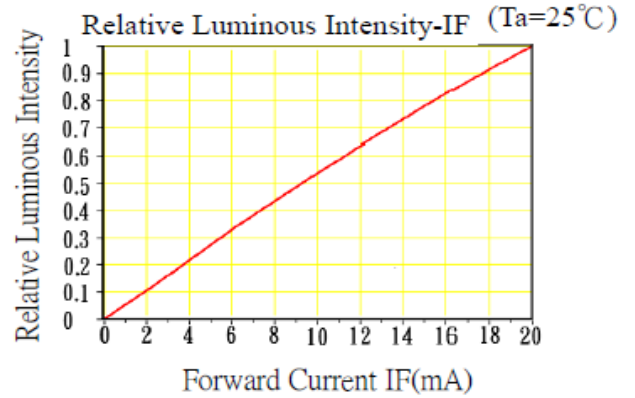
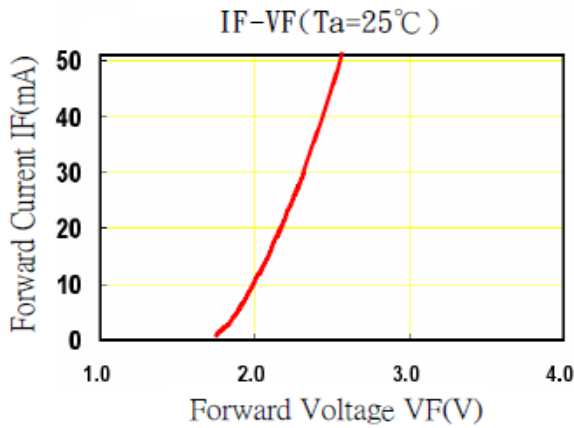
Bin	Min.	Max.	Unit
8	5	8	mcd
9	8	12.5	
A	12.5	16	
B	16	20	
C	20	25	

### Dominant Wavelength λ<sub>D</sub> @ I<sub>F</sub>=20mA

Bin	Min.	Max.	Unit
I	568	572	nm
J	572	576	

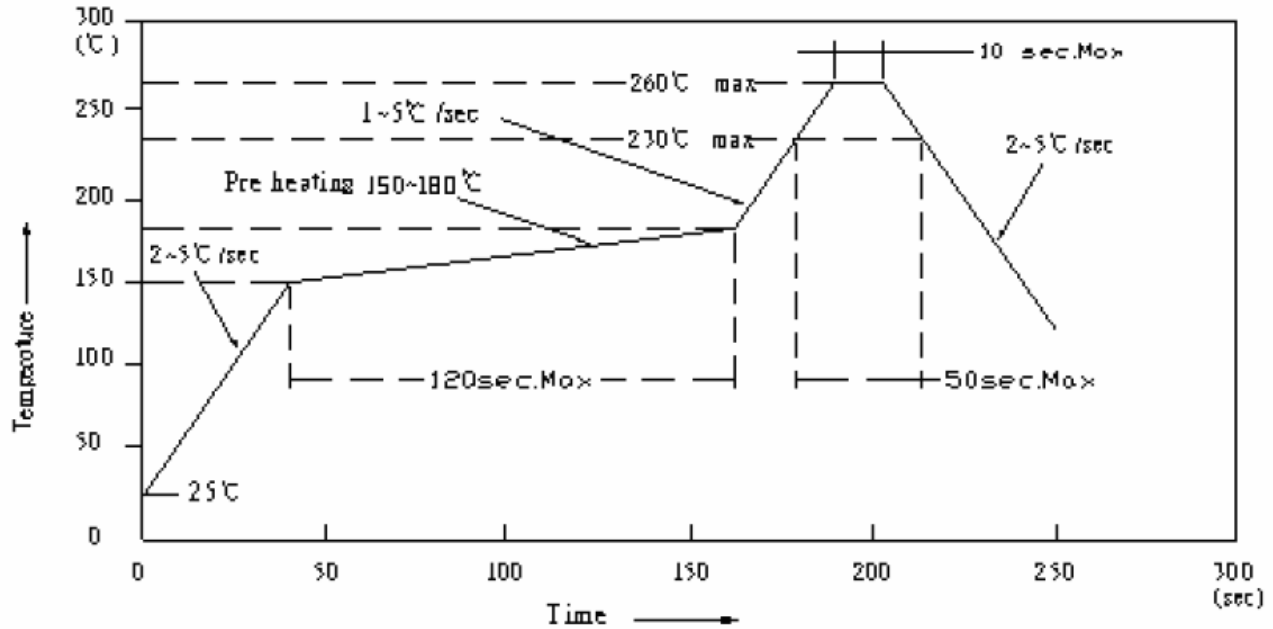
## Characteristic Curves

GaP

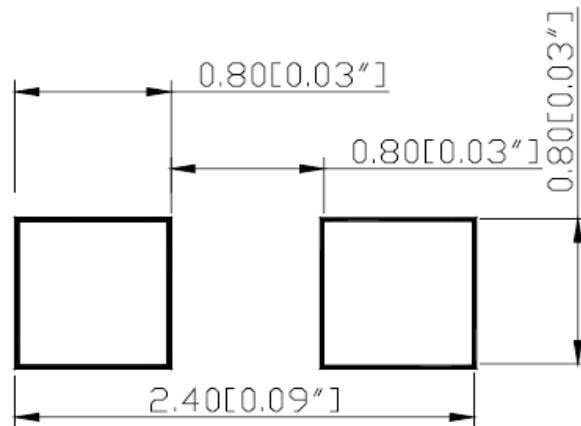


## Solder Profile & Footprint

- Recommended tin solder specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



### RECOMMEND PAD LAYOUT

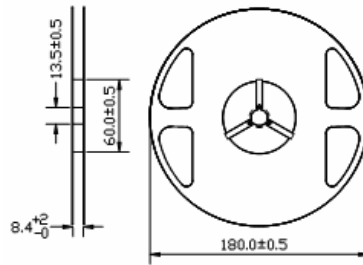


Units: mm

tolerance: +/- 0.1mm

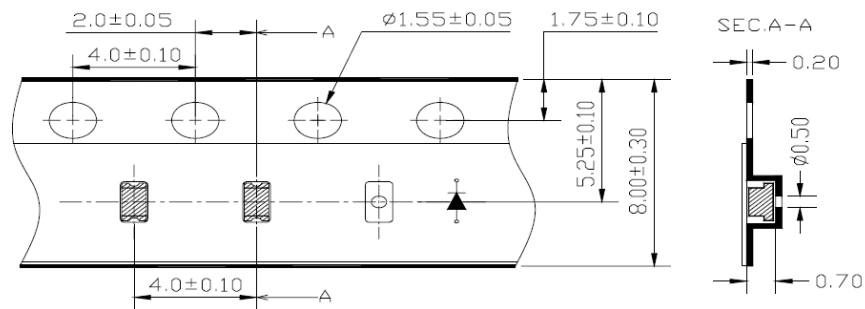
## Packing

### Reel Dimension:



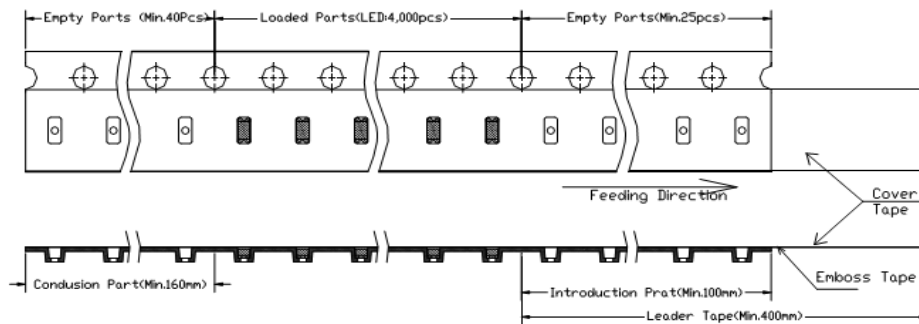
Unit: mm

### Tape Dimension:

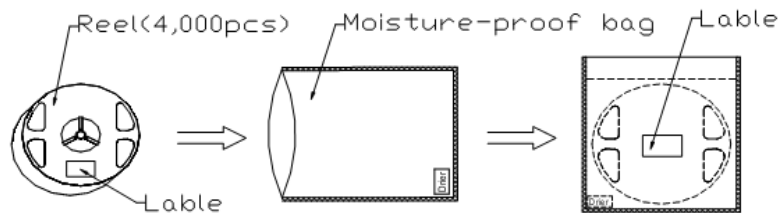


Unit: mm

### Arrangement of Tape:



### Packaging Specification:



Product: QBLP601-YG	Date: March 28, 2014	Page 7 of 9
	Version# 1.1	

**Labeling**

Part No: \_\_\_\_\_

Customer P/N: \_\_\_\_\_

Item: \_\_\_\_\_

Q'ty: \_\_\_\_\_

Vf: \_\_\_\_\_

Iv: \_\_\_\_\_

WI: \_\_\_\_\_

Date: \_\_\_\_\_

**Made in China****Ordering Information**

Part #	Orderable Part #	Spec Range	Quantity per reel
QBLP601-YG	QBLP601-YG	Iv=5mcd typ. @ I <sub>F</sub> = 10mA; 10 mcd typ. @ I <sub>F</sub> = 20mA / Color = 568-576nm	4,000 units

Product: QBLP601-YG	Date: March 28, 2014	Page 8 of 9
	Version# 1.1	



**Revision History**

Description:	Revision #	Revision Date
New Release of QBLP601-YG	V1.0	03/31/2011
Update to the new format/ brightness bins	V1.1	03/28/2014

**Disclaimer**

QT-BRIGHTTEK reserves the right to make changes without further notice to any products herein to improve reliability, function or design. QT-BRIGHTTEK does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, nor the rights of others.

**Life Support Policy**

QT-BRIGHTTEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of QT-BRIGHTTEK. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Product: QBLP601-YG	Date: March 28, 2014	Page 9 of 9
	Version# 1.1	